

On-Board® *IS* Cryopump Installation Instructions

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Safety Conventions

Introduction

All CTI-Cryogenics products are safe and dependable when used properly. Follow all safety precautions during installation, normal operation, and when servicing CTI-Cryogenics products.

This chapter explains the safety conventions used throughout this manual. CTI uses a specific format for cautions and warnings, which includes standard signal words and safety shapes.

See also the *Customer Support* appendix or call your local Customer Support Center for assistance.

Signal Word Descriptions

All cautions and warnings contain signal words, which call attention to safety messages and designate the degree of hazard seriousness. The following table shows the signal words and their meanings that may be used in this document.

Term	Example	Definition
CAUTION		A signal word accompanied by a safety shape that indicates a potentially hazardous situation or unsafe practice.
		If not avoided, the action may result in minor or moderate personal injury or equipment damage . A CAUTION is highlighted in yellow.
CAUTION	CAUTION	A signal word that indicates a situation or unsafe practice, which if not avoided may result in equipment damage . A CAUTION is highlighted in yellow.
WARNING		A signal word accompanied by a safety shape that indicates indicates a potentially hazardous situation.
		If not avoided, the action may result in serious injury or death . A WARNING is highlighted in orange.



Safety Shape Descriptions

All cautions and warnings contain safety shapes, which have specific safety meanings. The following table shows some of the safety shapes used in this document and their meanings.

Example	Term	Shape Definition	
General Warning	General Warning	Indicates a general hazard. Details about this hazard should be noted in the safety notice explanation.	
	Note that this shape may also be used with specific signal words.		
4	High Voltage	Indicates a high voltage hazard.	
	Hot Surface	Indicates a surface is hot enough to cause discomfort or a burn.	

References

For more information about safety standards, see the following documents:

- ISO 7010: 2003(E), Graphic symbols Safety colours and safety signs Safety signs used in workplaces and public areas
- ISO 3864-1: 2002(E), Graphic symbols Safety colours and safety signs Part 1: Design principles for safety signs in workplaces and public areas



Section 1 - On-Board *IS* Cryopump Description

Introduction

The On-Board *IS* Cryopump provides fast, clean pumping of all gases in the 10⁻³ to 10⁻⁹ torr range by condensing gas at low temperatures to achieve low vapor pressures, allowing high pumping speeds and throughputs.

The On-Board *IS* Cryopump is highly-reliable and requires little maintenance. Since the Cryopump exposes no moving parts, operating fluids, or backing pumps to the vacuum, there is no possibility of system or process contamination from the Cryopump.

Installation Instructions

The Installation Instructions for the On-Board *IS* Cryopump provide easily accessible information. All personnel with maintenance responsibilities should become familiar with the contents of these instructions to ensure high performance and safe and reliable operation of the Cryopump.

Microprocessor-Based Control System

The On-Board *IS* Cryopump is equipped with a microprocessor-based control system that allows both monitoring and control of a wide range of important vacuum system functions.

Refer to the *On-Board IS Cryopump System Operation Guide* Helix part number 8040647, that came with the *IS* Controller, for a complete description of the numerous operational functions that are available.



Remote Operation Options

The On-Board *IS* Cryopump can be controlled remotely using an RS-232 protocol. Multiple Cryopumps can be networked using a proprietary BITBUSTM protocol to an *IS* Controller. In this configuration, the networked Cryopumps are managed as a group by the *IS* Controller which coordinates group regeneration cycles and provides a standardized communication link to the process tool host computer. The *IS* Controller allows all Cryopumps to be addressed by the host system through a single RS-232 port. Using this approach, control of the networked Cryopumps can be fully integrated with the process tool control through RS-232 communication.

Figure 1-1 through Figure 1-4 shows the On-Board IS cryopumps.

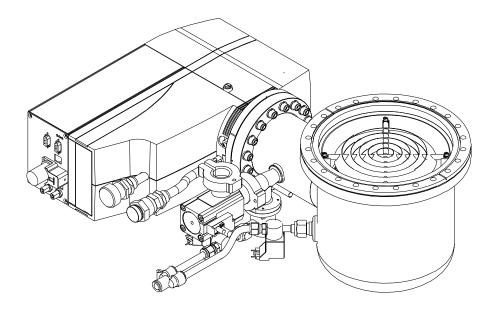


Figure 1-1: On-Board IS 8F (Flat) Cryopump



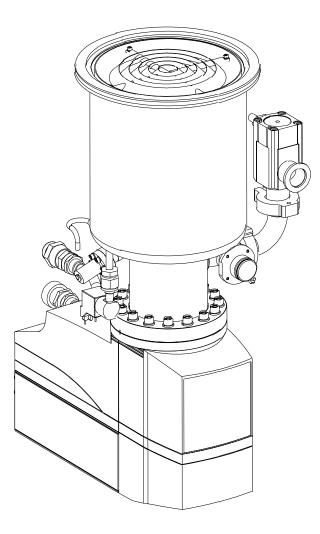


Figure 1-2: On-Board IS 8 (Straight) Cryopump



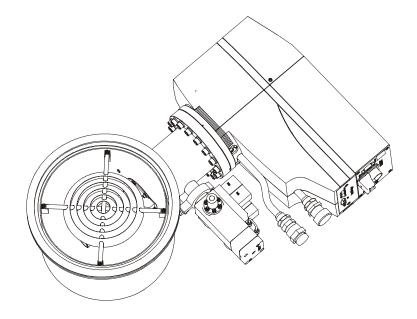


Figure 1-3: On-Board IS 250F and 250FE Cryopump

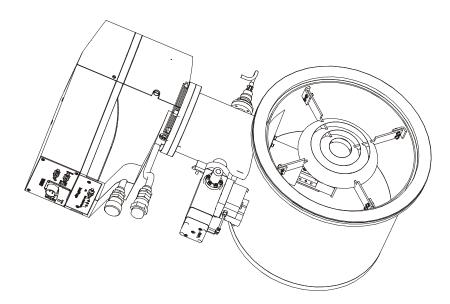


Figure 1-4: On-Board IS 320F and 320FE Cryopump



Performance Specifications

Parameter		Specifications
		Roughing Valve
		Purge Valve
		Cryopump TC Gauge
T / / 1TT 1		1st Stage Diode
Integrated Hardware		2nd Stage Diode
		1st Stage Heater
		2nd Stage Heater
		RS-232 Interface
	Water	4,000 liters/sec
Dumning Speeds	Nitrogen	1,500 liters/sec
Pumping Speeds	Hydrogen	2,200 liters/sec
	Argon	1,200 liters/sec
Argon Throughput at	20K*	250 - 700 sccm (torr-liters/sec)
	Argon	1000 std. liters @ 5 x 10 ⁻⁶ torr
Capacities		750 std. liters @ 5 x 10 ⁻⁷ torr (recovery in 30 seconds)
Capacifics	Hydrogen	12 std. liters @ 5 x 10 ⁻⁶ torr
	Nitrogen	550 std. liters (recovery to 5 x 10 ⁻⁷ torr in 30 seconds)
Crossover		150 torr-liters
Full Regeneration - Cold to Cold (with 1 minute extended purge)		\leq 90 minutes (1 pump/1 compressor)
		\leq 120 minutes (5 pumps/1 compressor)
Fast Regeneration		\leq 35 minutes (1 pump/1 compressor)
		\leq 60 minutes (5 pumps/1 compressor)
Dimensions		Refer to Installation/Interface Drawing
Weight		67 lbs.
*Depends upon system configuration.		

Table 1-1: On-Board IS8F Cryopump Specifications(Helix Part Number 8185038 with Chevron Array)



Para	meter	Specifications	
		Roughing Valve	
		Purge Valve	
		Cryopump TC Gauge	
		1st Stage Diode	
Integrated Hardware		2nd Stage Diode	
		1st Stage Heater	
		2nd Stage Heater	
		RS-232 Interface	
	Water	4,000 liters/sec	
Downing Crossela	Nitrogen	1,500 liters/sec	
Pumping Speeds	Hydrogen	2,500 liters/sec	
Argon		1,200 liters/sec	
Argon Throughput at 20K*		250 - 700 sccm (torr-liters/sec)	
		1000 std. liters @ 5 x 10 ⁻⁶ torr	
a iii	Argon	> 5000 cycles @ 10 torr-liter	
Capacities		(burst recovery to 5 x 10^{-6} torr)	
	Hydrogen	12 std. liters @ 5 x 10 ⁻⁶ torr	
Crossover		150 torr-liters	
Full Regeneration - Co	old to Cold	≤ 90 minutes (1 pump/1 compressor)	
(with 1 minute extended		\leq 120 minutes (5 pumps/1 compressor)	
		≤ 35 minutes (1 pump/1 compressor)	
Fast Regeneration		\leq 60 minutes (5 pumps/1 compressor)	
Dimensions		Refer to Installation/Interface Drawing	
Weight		72 lbs.	
*Depends upon system con	figuration.		

Table 1-2: On-Board IS 8 Cryopump Specifications(Helix Part Number 8185039 with Chevron Array)



Table 1-3: On-Board IS 250F and 250FE Cryopumps for Implant Specifications	
(Helix Part Numbers 8185062G001 and 8185072G001)	

Para	meter	Specifications
		Roughing Valve
		Purge Valve
		Cryopump TC Gauge
· · · · · · · · · · · · · · · · · · ·		1st Stage Diode
Integrated Hardware		2nd Stage Diode
		1st Stage Heater
		2nd Stage Heater
		RS-232 Interface
	Water	6,500 liters/sec
Pumping Speeds	ping Speeds Nitrogen	2,200 liters/sec
r uniping Speeds	Hydrogen	4,500 liters/sec (On-Board <i>IS</i> 250F) 7000 liters/sec (On-Board <i>IS</i> 250FE)
a	TT 1	
Capacities	Hydrogen	24 std. liters @ 5 x 10 ⁻⁶ torr
Crossover		150 torr-liters
		\leq 115 minutes (1 pump/1 compressor)
Full Regeneration - C (with 20 minutes exte		\leq 115 minutes (4 pumps/1 compressor) with TI = 100K
		≤ 50 minutes (1 pump/1 compressor)
Fast Regeneration		\leq 50 minutes (4 pumps/1 compressor) with TI = 100K
Dimensions		Refer to Installation/Interface Drawing
Weight		72 lbs.
*Depends upon system con	nfiguration.	



Parameter		Specif	fications	
		Roughing Valve		
		Purge Valve		
		Cryopump TC Gauge		
		1st Stage Diode		
Integrated Hardware		2nd Stage Diode		
		1st Stage Heater		
		2nd Stage Heater		
		RS-232 Interface		
		On-Board IS 320F	On-Board IS 320FE	
	Water	11,000 liters/sec	11,000 liters/sec	
Pumping Speeds	Nitrogen	3,300 liters/sec	3,600 liters/sec	
	Hydrogen	9,000 liters/sec	12,500 liters/sec	
	Argon	2,700 liters/sec	3,000 liters/sec	
Capacities:	Hydrogen	30 std. liters @ 5 x 10 ⁻⁶ torr		
Crossover		300 torr-liters		
	114. 0.11	\leq 150 minutes (1 pump/1 co	ompressor)	
Full Regeneration - Co (with 20 minutes exten		\leq 150 minutes (3 pumps/1 d	\leq 150 minutes (3 pumps/1 compressor)	
(with 20 minutes exter	laca purge)	with $TI = 100K$		
		\leq 75 minutes (1 pump/1 con	mpressor)	
Fast Regeneration		\leq 75 minutes (3 pumps/1 co	\leq 75 minutes (3 pumps/1 compressor)	
		with $TI = 100K$		
Dimensions		Refer to Installation/Interfa	Refer to Installation/Interface Drawing	
Weight		100 lbs.	100 lbs.	
*Depends upon system con	figuration.			

Table 1-4: On-Board IS 320F and 320FE Cryopumps for Implant Specifications(Helix Part Numbers 8185059G001 and 8185049G001)



Theory of Operation

The On-Board *IS* Cryopumps consist of a refrigerator or coldhead, vacuum vessel, electronics, valves, heaters and temperature and pressure sensors for controlling and monitoring the cryopump.

Cryopumps operate on the principle that gas molecules encountering a sufficiently cold surface (array) will be condensed and held at an extremely low vapor pressure, effectively trapping the molecules and preventing them from returning to the vacuum chamber. Gas molecules that travel into a cryopump are condensed or adsorbed on the cryogenically-cooled arrays and thereby are removed or *pumped* from the vacuum chamber.

The On-Board *IS* Cryopump contains two arrays. The first stage array or inlet array normally operates at temperatures between 65 -120K and is primarily used to pump water vapor.

NOTE: First stage temperature can be operated outside the normal operating temperature range. Refer to Appendix A - Customer Support Information and contact the Customer Support Center for more information.

The second stage array operates at temperatures between 10-20K and is used to pump air gasses such as nitrogen, argon, and oxygen. Activated charcoal is attached to the second stage array, and is used to cryoadsorb hydrogen, helium, and neon. The Cryopump arrays are cooled using a closed cycle, Gifford McMahan refrigeration cycle utilizing compressed gaseous helium as the refrigerant.

Since the Cryopump is a capture pump, it requires a regeneration cycle when it reaches capacity. The On-Board *IS* Cryopump uses an integrated microprocessor, variable speed motor and heaters to provide a fast and thorough regeneration cycle.

The On-Board *IS* Cryopump system consists of the cryopump and a remotely located On-Board *IS* Compressor which provides the compressed helium. The On-Board *IS* Compressor can provide helium for multiple Cryopumps through helium supply and return lines. The *IS* Controller coordinates all Helix Intercomponent Network communications. A typical On-Board *IS* Cryopump system is shown in Figure 1-5.



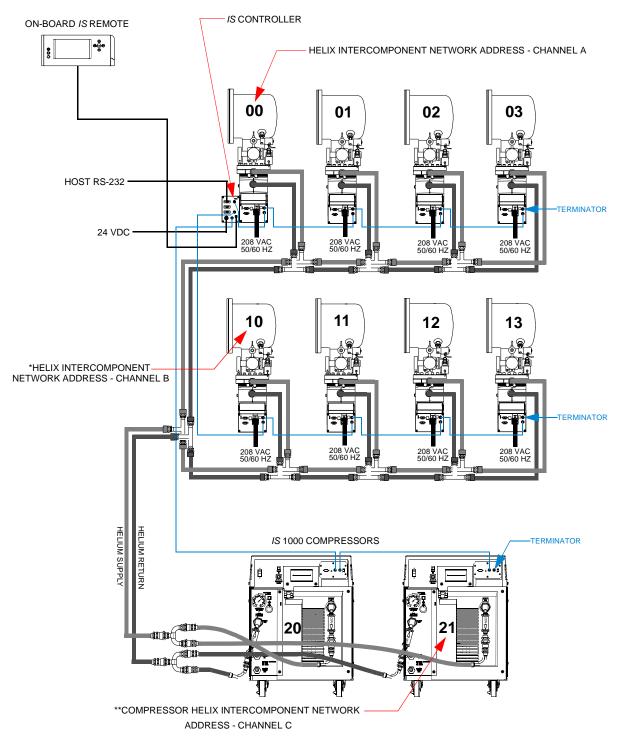


Figure 1-5: Typical On-Board IS Cryopump System

*Note: If the address is set to 0, it appears as 10 on Channel B. **Note: If the address is set to 2, it appears as 20 on Channel C.



Cold Head

The cold head consists of a motor, helium supply and return valves, first and second stage displacer assembly and a cylinder. The cylinder is a welded stainless steel cylinder that is installed in the Cryopump vacuum vessel. The first and second stage arrays are secured to the cylinder inside the Cryopump vacuum vessel.

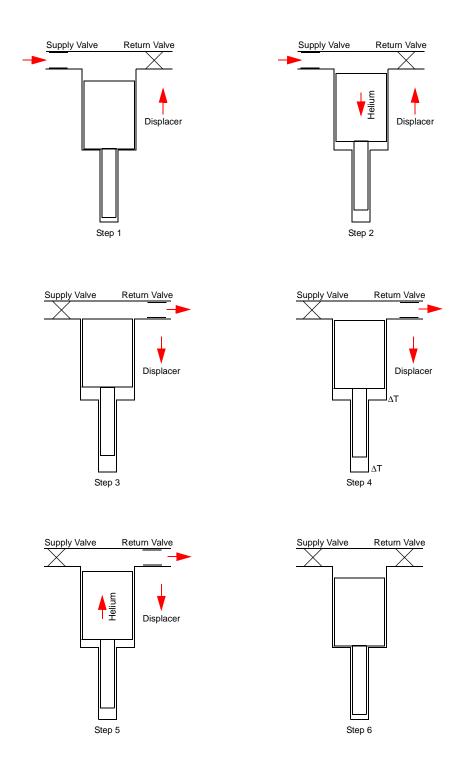
The displacer assembly is made up of a first and second stage displacer. The displacers are packed with a heat exchange matrix that is used as a thermal reservoir. Each displacer has a seal that causes the helium to flow through the heat exchange matrix inside the displacers rather than between the displacer and the cylinder wall.

Within the coldhead, the motor cycles the displacer assembly up and down the cylinder and actuates the helium supply and return valves. The motor is a direct-drive variable-speed motor, operating between 40-144 rpm.

The following steps and Figure 1-6 describe the Gifford McMahan refrigeration cycle:

- 1. When the displacer is at the bottom of the cylinder, the helium supply valve opens allowing high pressure helium to fill the cylinder.
- 2. As the displacer rises, the helium flows through the matrix in the displacers to the bottom of the cylinder.
- 3. When the displacer reaches the top of the cylinder, the supply valve closes, and the return valve opens allowing the gas to expand and cool.
- 4. The temperature drop in the expanded helium cools the heat stations, cooling the cryopump arrays.
- 5. The cooled helium passes out through the return valve, cooling the matrix in the displacers as the displacers move toward the bottom of the cylinder.
- 6. Steps 1-5 are repeated continuously. With each cycle, the incoming helium is pre-cooled by the matrix as it flows through the displacers, providing an additional increment of refrigeration.









Component Description

The On-Board *IS* Cryopump is driven by a variable speed motor and controlled by an advanced microprocessor On-Board *IS* Module. The On-Board *IS* Module conditions the input power and provides RS-232 and BitBus communication capability. The communication protocol and commands are compatible with all On-Board RS-232 and BitBus network commands.

Inlet Port

The Inlet Port is the opening of the vacuum vessel through which process gases enter the cryopump. The Inlet Port is connected to the vacuum chamber via the gate valve.

Vacuum Vessel

The Vacuum Vessel contains the first and second stage condensing arrays which are cooled to condense process gases.

First Stage Array

The First Stage Array is the first condensing array that a process gas molecule encounters within the Cryopump. Gases such as water vapor and hydrocarbons are condensed onto the first stage array which operates at 65 to 120K. The On-Board *IS* Cryopump utilizes either a chevron array or a sputter plate for the first stage array. The chevron array maximizes the Cryopump pumping speed for all gasses. The sputter plate maximizes the water pumping speed while maintaining reduced process gas pumping speeds.

Second Stage Array

The Second Stage Array condenses gases such as N_2 , O_2 , Ar, CO_2 , and CO and operates at temperatures from 10 to 20K. Activated charcoal is attached to the second stage array which cryoadsorbs H_2 , He, and Ne.

Refrigerator

The refrigerator consists of a two-stage cylinder (part of the vacuum vessel) and a coldhead assembly, that together produce closed-cycle refrigeration at temperatures that range from 65 to 120K for the first stage and 10 to 20K for the second stage, depending on operating conditions.



First and Second Stage Heaters

The first and second stage heaters are mounted to the cold head cylinder, are used to warm the Cryopump during a regeneration cycle, and help maintain array temperature settings.

Thermocouple (TC) Gauge

The TC Gauge measures cryopump pressure during a regeneration cycle and sends pressure information to the On-Board *IS* Module.

Diode Connector

The Diode Connector is connected to the diodes that are mounted on the first and second stage arrays of the Cryopump. The diodes measure the first and second stage array temperatures. Array temperature information is sent to the On-Board *IS* Module.

On-Board IS Cryopump Valve Operation

The following describes the operation of the valves in the 8 and 8F On-Board *IS* cryopumps.

Purge Valve

The purge valve controls the flow of nitrogen to the Cryopump vessel. During a regeneration cycle, the purge valve opens and allows nitrogen to flow through the vessel to dilute and remove the cryopumped gases.

Roughing Valve

The Roughing Valve connects to a system rough pump or dry pump. The rough valve is used during the Cryopump regeneration cycle to rough the Cryopump to rough vacuum (approximately 50-100 microns) before the Cryopump begins to cool down.

Exhaust Purge Valve

PVD: The Exhaust Purge Valve purges room temperature nitrogen across the O-ring of the Cryopump relief valve to prevent the O-ring from getting too cold during regeneration. The exhaust purge valve actuates whenever the Cryopump rough valve is actuated.

Implant: The Exhaust Purge Valve suppresses oxygen in the exhaust line during regeneration. It is independently controlled.



Vacuum Vessel Pressure Relief Exhaust Valve

The Vacuum Vessel Pressure Relief Exhaust Valve is a spring loaded valve which releases process gases during a regeneration cycle. The relief valve opens at approximately 2-3 psig.

On-Board IS Cryopump Multi-Function Valve Operation

The multi-function valve combines the functions of the rough valve, pump purge valve, exhaust purge valve, and relief valve. The basic functions as described previously also apply, except that all valves on the Multi-Function valve are piloted, and therefore require high pressure air for operation. On the 250mm and 320mm On-Board *IS* Cryopumps with the IntelliPurge system, the Exhaust Purge and Pump Purge valves are normally open valves, requiring air to close, and air and Nitrogen to open. See the description of the IntelliPurge system in the Connecting IntelliPurge section for details.

Helium Supply Fitting

The Helium Supply Fitting provides a connection for high pressure compressed helium from the *IS* 1000 Compressor to the Cryopump.

Helium Return Fitting

The Helium Return Fitting provides a connection to return low pressure helium which has been cycled through the Cryopump to the On-Board *IS* Compressor.



On-Board *IS* **8F Cryopump Component Description and Facility Requirements**

	Component Name	Facility Requirement or Spe	ecification	
1	TC Gauge	N/A		
2	Vacuum Vessel Mounting Flange	Contact Helix for the Installation	/Interface drawing.	
3	Cold Throttle Plate (covers First Stage Array)	N/A		
4	Roughing Valve Pilot	Supply port 1/8" one-touch tube connection 60 psig minimum	Exhaust port 1/4" one-touch tube connection 80 psig maximum	
5	Roughing Valve	N/NW-25 ISO KF flange	10 cfm	
6	Pump Purge Valve and Exhaust Purge Valve Nitrogen Connection	3/8" one-touch tube connection Minimum 4scfm	60 psig minimum 80 psig maximum	
7	Helium Return Fitting	See Figure 2-9.		
8	Module Power Connector	208 VAC (range: 180 - 253 VAC) 5 amps 50/60 Hz	Single phase Also see Figure 1-12.	
9	Communication Module	N/A, see Figure 2-9.		
10	Diode Connector	N/A		
11	Address Switches	See Figure 1-12.		
12	Status LEDs	See Figure 1-12.		
13	Host (RS-232) Connector	See Figure 1-12.		
14	Service (RS-232) Connector	See Figure 1-12.		
15	Pump Purge Valve	See component number 6 on this	page.	
16	Pressure Relief Valve Adapter	1/2" Female NPT (for Pressure Relief Valve, internal component)		
17	Exhaust Purge Valve	See component number 6 on this page.		
18	Helium Supply Fitting	See Figure 2-9.		
19	On-Board IS Remote Connector	See Figure 1-12.		
20	Helix Intercomponent Network Connectors	See Figure 1-12.		

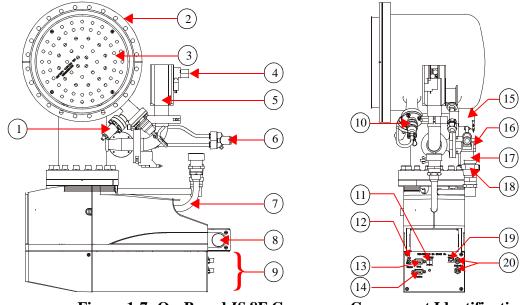


Figure 1-7: On-Board IS 8F Cryopump Component Identification



On-Board *IS* **8F** Cryopump, with the Multi-Function Valve, Component Description and Facility Requirements

	Component Name	Facility Requirement	or Specification	
1	*TC Gauge	N/A		
2	Address Switches	See Figure 1-12.		
3	Status LEDs	See Figure 1-12.		
4	Host (RS-232) Connector	See Figure 1-12.		
5	Service (RS-232) Connector	See Figure 1-12.		
6	*Multi-Function Valve Pilot	1/4" one-touch tube connection	60 psig minimum 80 psig maximum	
7	Diode Connector	N/A		
8	On-Board IS Remote Connector	See Figure 1-12.		
9	Helix Intercomponent Network Connectors	See Figure 1-12.		
10	Module Power Connector/Module Interlock	208 VAC (range: 180 - 253 VAC) 5 amps	50/60 Hz Single phase Also see Figure 1-12.	
11	Vacuum Vessel Mounting Flange	Contact Helix for the Install	lation/Interface drawing.	
12	First Stage Array (Visible on the Front)	N/A		
13	Multi-Function Valve	N/A		
14	*Pump Purge Valve and Exhaust Purge Valve Nitrogen Connection	Minimum 4scfm 1/8" Female NPT	PVD: Implant: 60 - 80 psig 25 - 30 psig	
15	*Pressure Relief Valve Adapter	1/2" Female NPT (for Press	sure Relief Valve, internal component)	
16	*Roughing Valve	N/NW-25 ISO KF flange	10 cfm	
	*Pump Purge Valve (Not Shown)	See component number 14	on this page.	
	*Exhaust Purge Valve (Not Shown)	See component number 14	on this page.	
17	Helium Supply Fitting	See Figure 2-9.		
18	Helium Return Fitting	See Figure 2-9.		
19	Communication Module	N/A, see Figure 2-9.		

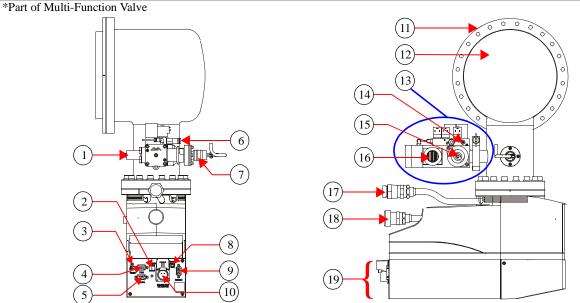
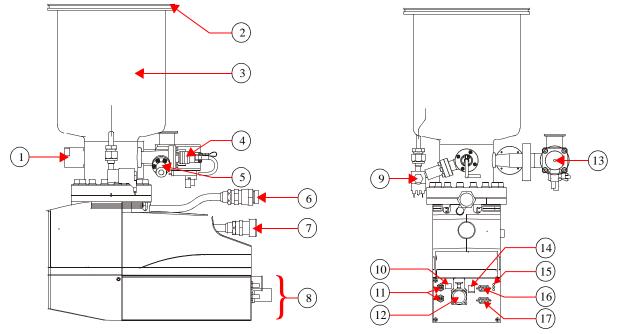


Figure 1-8: On-Board IS 8F Cryopump, with the Multi-Function Valve, Component Identification



On-Board *IS* 8 Cryopump Component Description and Facility Requirements

	Component Name	Facility Requirement or S	Specification	
1	Pressure Relief Valve Adapter	1/2" Female NPT (for Pressur	e Relief Valve, in	nternal component)
2	Vacuum Vessel Mounting Flange	Contact Helix for the Installat	ion/Interface dra	wing.
3	Vacuum Vessel	N/A		
4	Diode Connector	N/A		
5	TC Gauge	N/A		
6	Helium Supply Fitting	See Figure 2-9.		
7	Helium Return Fitting	See Figure 2-9.		
8	Communication Module	N/A, see Figure 2-9.		
9	Pump Purge Valve	1/8" NPT Female Minimum 2 scfm	60 psig minimu 80 psig maximu	
10	On-Board IS Remote Connector	See Figure 1-12.		
11	Helix Intercomponent Network Connectors	See Figure 1-12.		
12	Module Power Connector/Module Interlock	208 VAC (range: 180 - 253 VAC) 5 amps	50/60 Hz Single phase Also see Figure	1-12.
13	Roughing Valve	N/NW-25 ISO KF flange	10 cfm	
14	Roughing Valve Pilot	Supply port 1/8" one-touch tube connection	PVD: 60 - 80 psig	Implant, with Multi- Funtion Valve: 25 - 30 psig
15	Address Switches	See Figure 1-12.		
16	Status LEDs	See Figure 1-12.		
17	Host (RS-232) Connector	See Figure 1-12.		
18	Service (RS-232) Connector	See Figure 1-12.		

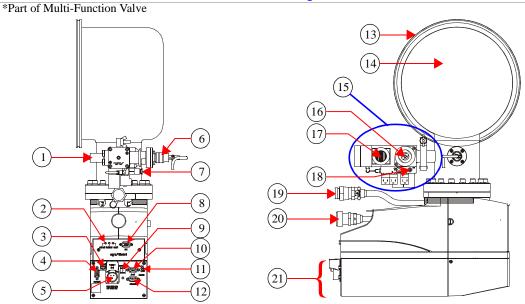


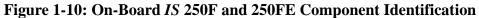




On-Board IS 250F and 250FE Cryopump Component Description and Facility Requirements

	Component Name	Facility Requirement or Spec	cification
1	*TC Gauge	N/A	
2	IntelliPurge LEDs	N/A	
3	On-Board IS Remote Connector	See Figure 1-12.	
4	Helix Intercomponent Network Connectors	See Figure 1-12.	
5	Module Power Connector/Module Interlock	208 VAC (range: 180 - 253 VAC) 5 amps	50/60 Hz Single phase Also see Figure 1-12.
6	Diode Connector	N/A	
7	*Multi-Function Valve Pilot	1/4" one-touch tube connection	60 psig minimum 80 psig maximum
8	IntelligPurge I/O Connection	High-density DB-15. See Table 2-	1 for pin descriptions.
9	Address Switches	See Figure 1-12.	
10	Status LEDs	See Figure 1-12.	
11	Host (RS-232) Connector	See Figure 1-12.	
12	Service (RS-232) Connector	See Figure 1-12.	
13	Vacuum Vessel Mounting Flange	Contact Helix for the Installation/	Interface drawing.
14	First Stage Array (Visible on the Front)	N/A	
15	Multi-Function Valve	N/A	
16	*Pressure Relief Valve Adapter	1/2" Female NPT (for Pressure Re	elief Valve, internal component)
17	*Roughing Valve	N/NW-25 ISO KF flange	17 - 20 cfm
18	*Pump Purge Valve and Exhaust Purge Valve Nitrogen Connection	Minimum 4.25scfm 1/8" Female NPT	25 psig minimum 30 psig maximum
	*Pump Purge Valve (Not Shown)	See component number 6 on this page.	
	*Exhaust Purge Valve (Not Shown)	See component number 6 on this	page.
19	Helium Supply Fitting	See Figure 2-9.	
20	Helium Return Fitting	See Figure 2-9.	
21	Communication Module	N/A, see Figure 2-9.	







On-Board *IS* **320F** and **320FE** Cryopump Component Description and Facility Requirements

	Component Name	Facility Requirement or Specification		
1	*TC Gauge	N/A		
2	IntelligPurge I/O Connection	N/A		
3	Address Switches	See Figure 1-12.		
4	Host (RS-232) Connector	See Figure 1-12.		
5	Status LEDs	See Figure 1-12.		
6	Service (RS-232) Connector	See Figure 1-12.		
7	*Multi-Function Valve Pilot	1/4" one-touch tube connection 60 psig minimum 80 psig maximum		
8	IntelliPurge LEDs	High-density DB-15. See Table 2-1 for pin descriptions.		
9	On-Board IS Remote Connector	See Figure 1-12.		
10	Helix Intercomponent Network Connectors	See Figure 1-12.		
11	Module Power Connector/Module Interlock	208 VAC (range: 180 - 253 VAC) 5 amps 50/60 Hz Single phase Also see Figure 1-12.		
12	Vacuum Vessel Mounting Flange	Contact Helix for the Installation/Interface drawing.		
13	First Stage Array (Visible on the Front)	N/A		
14	Multi-Function Valve	N/A		
15	*Pump Purge Valve and Exhaust Purge Valve Nitrogen Connection	Minimum 4.25 scfm25 psig minimum1/8" Female NPT30 psig maximum		
16	*Pressure Relief Valve Adapter	1/2" Female NPT (for Pressure Relief Valve, internal component)		
17	*Roughing Valve	N/NW-25 ISO KF flange 17 - 20 cfm		
	*Pump Purge Valve (Not Shown)	See component number 6 on this page.		
	*Exhaust Purge Valve (Not Shown)	See component number 6 on this page.		
18	Helium Supply Fitting	See Figure 2-9.		
19	Helium Return Fitting	See Figure 2-9.		
20	Communication Module	N/A, see Figure 2-9.		
21	Diode Connector	N/A		
	*Part of Multi-Function Valve 12 13 14 15 16 10 10 10 10 10 10 10 10 10 10			

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Figure 1-11: On-Board IS 320F and 320FE Component Identification

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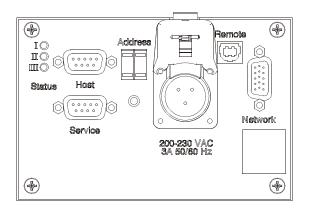
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On-Board IS Module

The On-Board *IS* Module controls the operation of the On-Board *IS* Cryopumps. In addition, the On-Board *IS* Module conditions the input power and provides host computer RS-232 and Network communication ports. Figure 1-12 shows the current On-Board *IS* module components, and Figure 1-13 shows the obsolete module components.





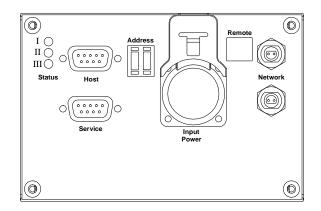


Figure 1-13: On-Board IS Obsolete Module Components



Status LEDs

The Status LEDs (I, II and III) give On-Board *IS* Cryopump, regeneration cycle and network communications status. Table 1-5 describes the LEDs on the Communication Module. Table 1-6 describes the IntelliPurge LEDs.

LED	Purpose	LED States			
		OFF	Amber	Green	
Ι	Cryopump Status	Motor OFF	1st and/or 2nd stage temperature control is OFF	Motor ON and 1st and 2nd stage temperature control ON.	
II	Regen Status	Normal Operation	Fast Regeneration Cycle in progress	Full regeneration cycle in progress.	
III	Network Communication Status	No network communication	Heater Fault Interrupt	Blinking LED - normal network communication.	

Table 1-5: Status LED Description

*Second stage temperature control is only available on On-Board *IS* Cryopumps for Implant.

Table 1-6:	IntelliPurge	Status LED	Description
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	Normal Operation	During Power Fail	Fault
Power LED	Green when unit is powered	Off	Green or Off
Enabled LED	Fully green when unit is fully charged	Fading green as unit discharges	Green or OFF
Service LED	Off	Off	Steady red when there is a fault in the redundant circuit. Flashing red when there is a significant component failure. UPS circuit may not work.

Control Module Components

The following sections describe the control module components on the On-Board *IS* cryopumps.



Host

The Host connector allows the On-Board *IS* Cryopump to communicate with a host computer using the CTI-Cryogenics command set. Refer to Table 1-7 for additional information on the communication protocol.

NOTE: Refer to Appendix A - Customer Support Information and call the Customer Support Center to request a copy of the **On-Board IS Cryopump System Command Set Manual** part number 8040677 if you are controlling the On-Board IS Cryopump system through a process tool host computer.

Table 1-7: RS-232 Communication Information

Parameter	Value
Baud Rate	9.6 kbps
Data Bits	7
Parity	Even
Number of Stop Bits	1

NOTE: The RS-232 Communication Cable must be fully shielded through to the outer shell. Use cable Helix part number 8132157 or equivalent.

Service

The Service connector allows CTI-Cryogenics service personnel to connect diagnostic equipment to On-Board *IS* Cryopump.

Address Selector Switch

The Address Selector Switch establishes the network address (0 - 9) of the On-Board *IS* Cryopump on the Helix Intercomponent Network. Use channel B to get pumps 10 - 19.

Input Power

The Input Power connector allows 208 VAC to be connected directly to the On-Board *IS* Cryopump. Refer to Table 2-1 for input power specifications.

Remote

The Remote connector allows a remote keypad/display to be connected to the On-Board *IS* Cryopump.

Network

The network connectors allow the On-Board *IS* Cryopump to be connected to the Helix Intercomponent Network.



Newer modules use HD15 connector for the Network connector. Adapter part number 8186509G001 is available to connect the HD15 style module to an existing two pin network cable.



Section 2 - Installation

Introduction

This installation information is for both experienced and inexperienced On-Board *IS* Cryopump system technicians.

The flowchart in Figure 2-1 shows the On-Board *IS* Cryopump installation process, which is explained in this chapter.

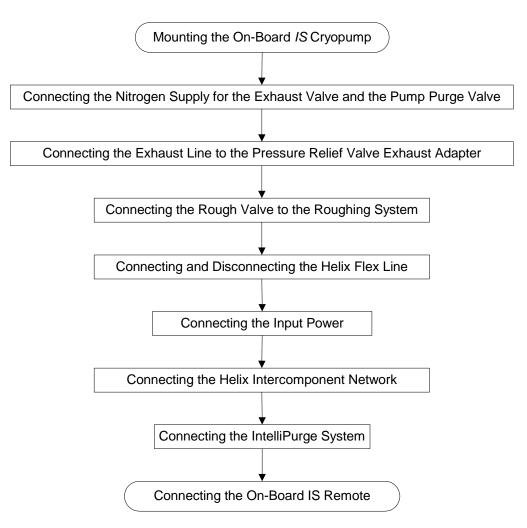


Figure 2-1: On-Board IS Cryopump Installation Process

See also Figure 2-16 for an example of a typical cryopump system.



Mounting the On-Board IS Cryopump

The On-Board *IS* Cryopump may be installed on the vacuum system Hi-Vac valve flange in any orientation without affecting its performance.

NOTE: Before mounting the On-Board IS Cryopump to the vacuum system, a high-vacuum isolation valve (Hi-Vac valve) should be installed between the On-Board IS Cryopump and the vacuum chamber to isolate the On-Board IS Cryopump from the chamber during rough pumping, cooldown, and regeneration.

Install the On-Board *IS* Cryopump on the vacuum system flange as shown in Figure 2-2 and as follows:

- 1. Remove the protective cover from the vacuum vessel mounting flange of the On-Board *IS* Cryopump.
- 2. Clean all sealing surfaces and install the metal seal gasket, centering ring (not shown), or O-ring.
- 3. Mount the On-Board *IS* Cryopump on the Hi-Vac valve or vacuum chamber mounting flange.
- 4. Install all claw clamps (not shown) or mounting bolts and lock washers.
- 5. Tighten the mounting bolts to mounting flange specifications.



A CAUTION

Heavy Object

To avoid injury when installing or removing cryopumps, use a lifting aid and proper lifting techniques.



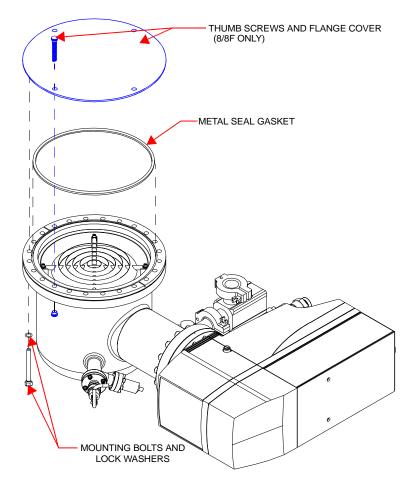


Figure 2-2: On-Board IS Cryopump and Metal Seal Gasket Installation (8F Cryopump)

Connecting the Nitrogen Supply for the Exhaust Valve and the Pump Purge Valve

Cryopumps create a vacuum by condensing and capturing gases, but the cryopumps have a finite capacity. Periodically they must be defrosted (regenerated) to restore full performance. A pressure relief valve on the cryopump vents the gases that are released during regeneration.

1. Connect tubing to the nitrogen purge connection as shown in Figure 2-3.

See page 1-16 through page 1-20 for component descriptions and facility requirements for each cryopump.

2. Adjust the nitrogen supply pressure regulator according to the specifications on page 1-16 through page 1-20.



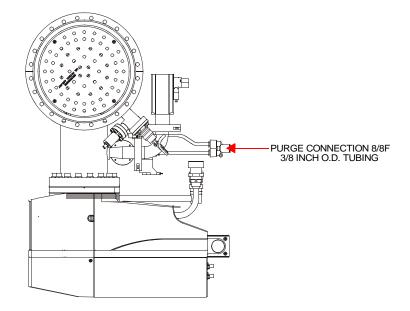
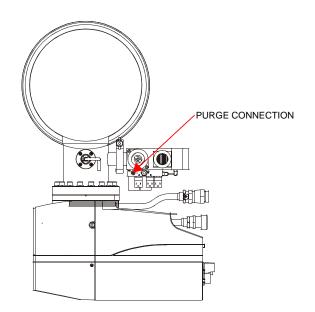


Figure 2-3: Nitrogen Connection







Connecting the Pressure Relief Valve and Exhaust System



AWARNING

Toxic, Corrosive, or Flammable Gas

To prevent personal injury, over pressurization, and equipment damage, connect an exhaust system vent line to the On-Board *IS* Cryopump pressure relief valve before pumping toxic, corrosive, or flammable gases.

An exhaust gas adapter is available from Helix. See Figure 2-5.



AWARNING

Exhaust Gas System Requirements

To avoid over pressurization and equipment damage, ensure the exhaust gas system vent line has a minimum inside diameter of 1/2 inch.

During regeneration, the exhaust system must be able to maintain a peak gas flow of 8 SCFM per cryopump.

For example: if 4 cryopumps are regenerated together, then the peak gas flow requirement is 32 SCFM.

- 1. Install a customer supplied 1/2 inch x 14 NPTF Tube Adapter in the exhaust gas adapter as shown in Figure 2-5.
- 2. Connect a customer supplied 1/2 inch exhaust system vent line to the Tube Adapter fitting as shown in Figure 2-5.



AWARNING

Pressure Relief Valve Operation

To avoid over pressurization, equipment damage, and improper pressure relief valve operation, ensure the 1.30-inch diameter x 1.38-inch long volume around the pressure relief valve remains unobstructed.



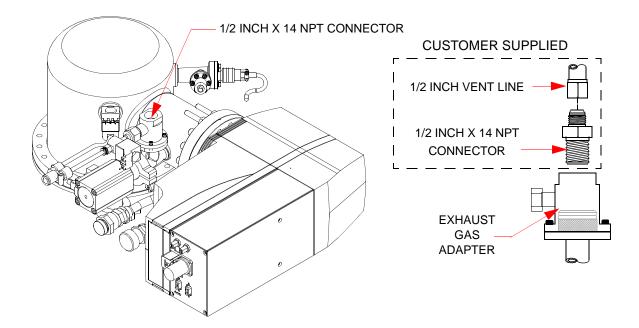


Figure 2-5: Pressure Relief Valve Exhaust Connection

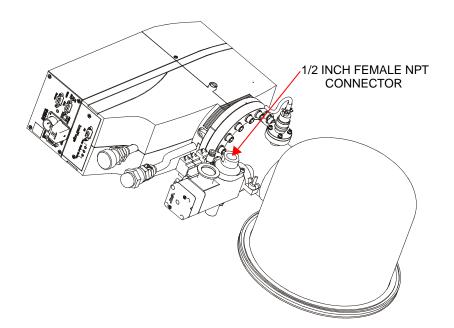


Figure 2-6: Pressure Relief Valve Exhaust Connection Through the Multi-Function Valve



Connecting the Roughing System

NOTE: The roughing system must provide 10 cfm (8, 8F) or 17 to 20 cfm (250, 320) to successfully utilize FastRegen capability. Measure in atmospheres at each On-Board IS Cryopump.

Connect your On-Board *IS* Cryopump to a roughing pump system using a roughing line with the largest inside diameter possible to minimize the roughing time required during start-up procedures prior to normal operation. The roughing pump should have a blank-off pressure of less than 20 microns.

NOTE: Refer to Figure 2-7 for all Roughing System Connections.

- 1. Remove the clamp and blank-off from the On-Board *IS* Cryopump Roughing System Connection.
- 2. Connect the roughing system line to the On-Board *IS* Cryopump roughing valve using the clamp provided. Tighten the clamp.
- 3. Attach the high pressure air or nitrogen to the Roughing Valve Pilot or Multi-Function Valve Pilot connection point.

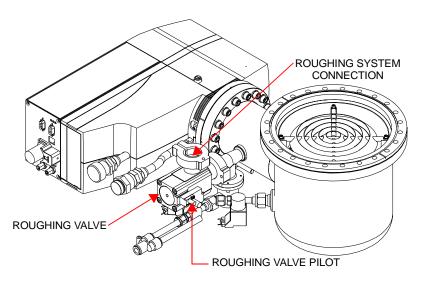


Figure 2-7: Roughing System Connections



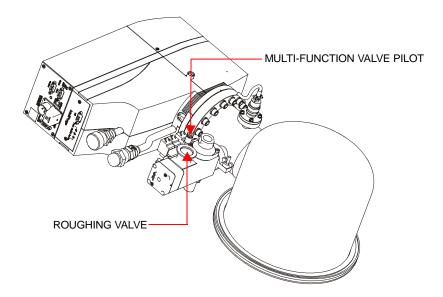


Figure 2-8: Roughing System Connections Through the Multi-Function Valve

Connecting and Disconnecting the Helium Flex Line



CAUTION

Equipment Damage

Make sure the helium flex lines are connected and disconnected from the *IS* 1000 Compressor appropriately, and as shown in Figure 2-9. Failure to follow this procedure could damage connector O-ring seals or cause a helium circuit leak.



Compressor Damage



To avoid damaging the compressor, do not connect multiple compressors to a single helium manifold that feeds a common supply and return header.

If it becomes necessary to make this connection, contact CTI-Cryogenics for specific instructions.

NOTE: The number of On-Board IS Cryopumps connected to an IS 1000 Compressor varies based upon the On-Board IS Cryopump models used. Contact your local Helix Customer Support Center if you need more information on specific compressor/pump applications.



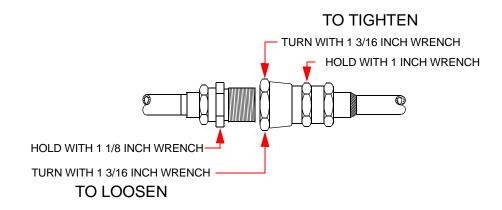


Figure 2-9: Connecting and Disconnecting Helium Flex Line Self Sealing Couplings

Connecting the Helium Flex Line

NOTE: Refer to Figure 2-9 *and* Figure 2-10 *during this procedure.*

- 1. Remove all dust plugs and caps from the Gas Supply and Return lines, and the *IS* 1000 Compressor and cryopump Supply and Return connectors. Check for the presence of a flat gasket in the male connector, and no gasket in the female connector.
- 2. Connect the Gas Return line to the GAS RETURN connector on the rear of the *IS* 1000 Compressor and then to the GAS RETURN connector on the On-Board *IS* Cryopump or helium manifold. Using two wrenches as shown in Figure 2-9, tighten the connector.
- 3. Connect the Gas Supply line to the GAS SUPPLY connector on the rear of the *IS* 1000 Compressor and then to the GAS SUPPLY connector on the On-Board *IS* Cryopump or helium manifold. Using two wrenches as shown in Figure 2-9, tighten the connector.
- 4. Attach the Supply and Return line identification labels to each end of the appropriate lines.
- 5. Refer to *On-Board IS 1000 Compressor Quick Installation Guide*, Helix part number 8040645 to verify proper system ("OFF" Condition) helium charge pressure.



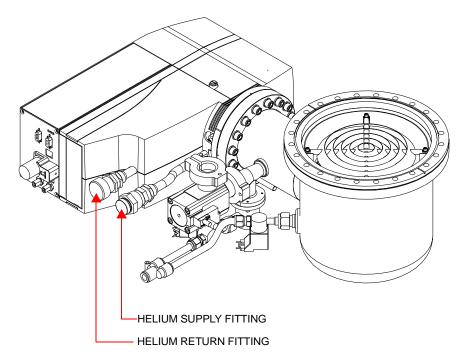


Figure 2-10: Helium Supply and Return Fitting Connections

Disconnecting the Helium Flex Line

NOTE: Refer to Figure 2-9 and Figure 2-10 during this procedure.

- 1. Using two wrenches as shown in Figure 2-9, disconnect the two self sealing coupling connectors quickly to minimize helium leakage.
- 2. Connect the helium-return line from the gas-return connector on the rear of the compressor to the gas-return connector on the On-Board *IS* Cryopump.
- 3. Connect the helium supply line from the supply connector on the cartridge to the gas-supply connector on the On-Board *IS* Cryopump.
- 4. Attach the supply and return line identification decals (CTI-Cryogenics supplied) to their respective connectors.



Connecting the Input Power Through the Module Power Connector



AWARNING

High Voltage

High voltage electric shock could cause severe injury or loss of life.

After you finish making all the appropriate connections on the module, ensure the On-Board *IS* Cryopump Power Cable is connected to a 208 VAC, Single-Phase 5 Amp source. Follow all appropriate electrical code requirements to avoid high voltage electric shock.

Refer to Figure 2-11 and Figure 2-12 as necessary throughout the following instructions.

- 1. Remove the four cover screws.
- 2. Slide the cover off the Module Power Connector.
- 3. Remove either one of the two punch-outs.
- 4. Feed the three wire ends of the input power cable through the punch-out hole so that the wire ends are near the connection points.
- 5. Attach the two wires (J1-A-Hot and J1-B-Hot) and one ground wire (J1-C-Ground) to the appropriate connection points.
- 6. Slide the cover on.
- 7. Replace the cover screws and tighten them.
- 8. Plug the other end of the cable into the power source.

NOTE: The power source end of the cable may be different from the example in Figure 2-12.



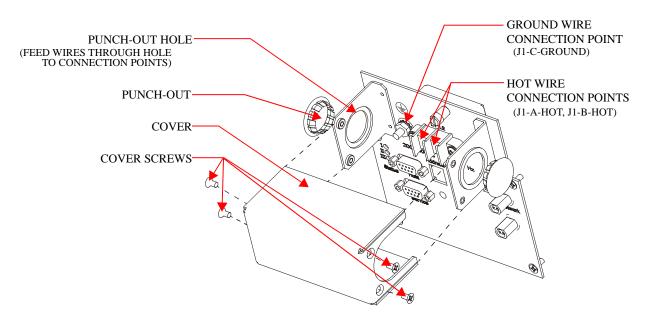


Figure 2-11: Input Power Cable Connection Points for the Module Power Connector

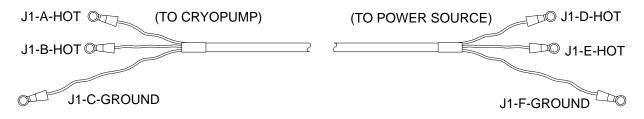
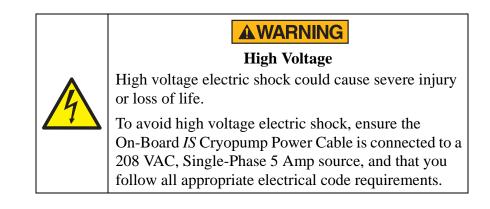


Figure 2-12: Input Power Cable

Connecting the Input Power Through the Communication Module







A CAUTION

Crush Hazard and Equipment Damage

To avoid dropping the On-Board *IS* Module, do not move the power cable clamp until you are ready to connect the power cord to the On-Board *IS* Cryopump. The power cable clamp assists in securing the On-Board *IS* Module to the pump.

- 1. Insert a flat blade screwdriver into the power cable clamp slot on the On-Board *IS* Cryopump Module as shown in Figure 2-13.
- 2. Move the screwdriver away from the power cable connector cap in Figure 2-13.

The screwdriver is held in place in the power cable clamp slot.

The power cable clamp releases the power cable connector cap and the locking tab appears.

- 3. Remove the power connector cap.
- 4. Connect the input power cable to the input power cable connector on the module, and then rotate the connector collar until tight.
- 5. Remove the screwdriver to lower the power cable clamp. This secures the input power cable with the power cable clamp.
- 6. Connect the opposite end of the input power cable to a local 208 VAC, Single-Phase 5 Amp source as shown in Figure 2-14.



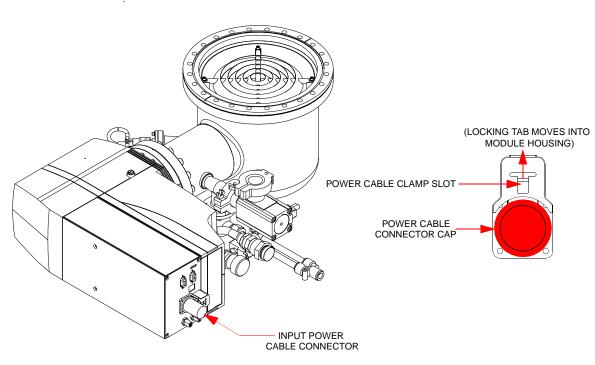


Figure 2-13: Input Power Cable Connection Point for the Module Power Connector

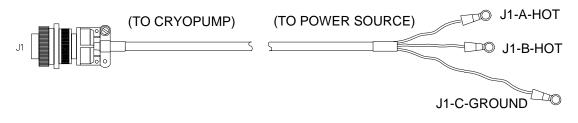


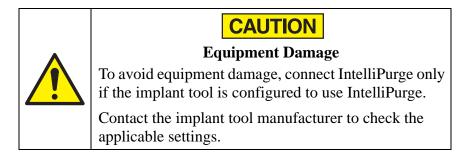
Figure 2-14: Input Power Cable

Connecting the Helix Intercomponent Network

NOTE: Refer to the **On-Board IS Controller Quick Installation Guide** (8040657) for information on connecting On-Board IS Cryopumps to the Helix Intercomponent Network.



Connecting IntelliPurge



Refer to Figure 2-15 as necessary for the following steps.

- 1. Connect the IntelliPurge I/O cable to the IntelliPurge Panel High Density DB15 Connector (not shown).
- 2. Connect the position sensors and control solenoid for the high-vacuum isolation valve to the IntelliPurge I/O cable.

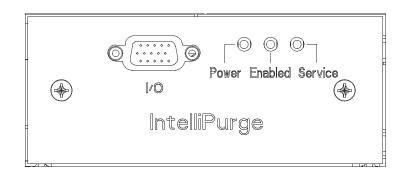


Figure 2-15: IntelliPurge Panel

Pin	Description
1	Overide Input (12V to 30V DC Overide Enable Voltage)
2	Overide Voltage Return
3	2nd Stage Warm Up Alarm Relay Normally Open Contact
4	2nd Stage Warm Up Alarm Relay Common Contact
5	2nd Stage Warm Up Alarm Relay Normally Closed Contact
6	24 VDC Return
7	24 VDC Output
8	24 VDC Return
9	Gate Valve Control Relay Normally Open Contact



Pin	Description
10	Gate Valve Control Relay Common Contact
11	Gate Valve Control Relay Normally Closed Contact
12	Gate Valve Open Sense Return
13	Gate Valve Open Sense Output
14	Gate Valve Closed Sense Return
15	Gate Valve Closed Sense Output

On-Board IS Remote Connections

If desired, an On-Board *IS* Remote can be connected to the On-Board *IS* Cryopump for direct communication with the Cryopump. Refer to the *On-Board IS Remote Quick Installation Guide* Helix part number 8040664 for information on how to install On-Board *IS* Remote.



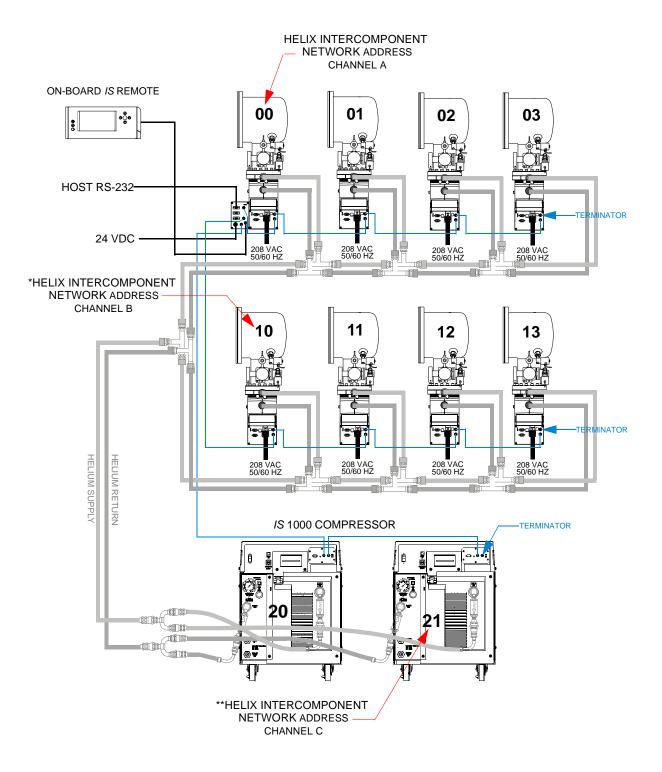


Figure 2-16: Typical On-Board IS Cryopump System

*Note: If the address is set to 0, it appears as 10 on Channel B. **Note: If the address is set to 2, it appears as 20 on Channel C.





Section 3 - Troubleshooting

Keeping a Normal Operation Log

Maintaining a log of certain parameters during normal operation can be a valuable tool in troubleshooting vacuum problems. The log may contain many parameters. However, the following minimum parameters should be included:

- chamber base pressure
- chamber pumpdown time
- chamber rate of rise

In addition, a baseline chamber RGA scan is useful for system troubleshooting

Assessing Basic Trouble

The primary indication of trouble in a vacuum pumping system is a rise in base pressure of the vacuum chamber. A rise in the base pressure may be caused by the following:

- a leak in the vacuum system
- the cryopump reaching capacity
- the cryopump running too warm

Typically a high base pressure is caused by an air-to-vacuum leak in the system.

If a leak in the vacuum system is suspected, do the following:

- 1. Isolate the On-Board *IS* Cryopump by closing the Hi-Vac valve and leak check the vacuum chamber.
- 2. Leak check all potential sources of leaks such as:
 - through process gas valves
 - chamber rough valves
 - chamber cooling lines



If no leaks are found, a leak may be present on the cryopump side of the Hi-Vac valve.

Leak checking on the cryopump side of the Hi-Vac valve should be performed with the On-Board *IS* Cryopump shut off and at room temperature.

Leak checking while the On-Board *IS* Cryopump is cold may mask leaks that are present (due to the ability of the cryopump to pump helium). If no leak is found, refer to the cryopump troubleshooting procedures summarized in Table 3-1.

Understanding Specific Causes and Corrective Actions

The problems presented in Table 3-1 are followed by possible causes and corrective actions. The causes and corresponding actions are listed in their order of probability of occurrence.

Problem	Possible Cause	Corrective Action
High vacuum system base	1.Air-to-vacuum leak in vacuum system or in cryopump.	 Check vacuum chamber and Hi-Vac valve for leaks. Check cryopump side of high vac valve for leaks.
pressure, and a cryopump temperature <i>below</i> 20K.	2.High partial pressure of noncondensables (helium, hydrogen, or neon) within the cryopump because the Second Stage array has reached full capacity.	2.Regenerate the cryopump as described in the On-Board IS Cryopump System Operation Guide Helix part number 8040647.

Table 3-1: On-Board IS Cryopump Troubleshooting Basic Causes and Actions



Problem	Possible Cause	Corrective Action
	1.Low helium pressure.	1.Check compressor Helium pressure. If the helium return pressure gauge reads below the normal operating pressure, add gas as described in the <i>On-Board</i> <i>IS 1000 Compressor</i> Installation, Operation, and Maintenance Instructions Helix part number 8040597.
High base pressure of vacuum system, and a cryopump temperature <i>above</i> 20K.	2.High partial pressure of non- condensables (helium, hydrogen, or neon) within the cryopump because the Second Stage array has reached full capacity.	2.Regenerate the cryopump as described in the appropriate <i>On-Board IS Cryopump System</i> <i>Operation Guide</i> Helix part number 8040647.
	3.Excessive thermal load on frontal array.	3.Look for new sources of thermal loads on the cryopump.
	4.Helium gas line contamination.	4.See part number (document) 8040720 for more information about helium circuit decontamination.

Table 3-1: On-Board IS Cryopump Troubleshooting Basic Causes and Actions



Problem	Possible Cause	Corrective Action
	1.Low helium pressure.	1.Add gas as described in the On-Board IS 1000 Compressor Installation, Operation and Maintenance Instructions Helix part number 8040597.
	2.Loose or disconnected helium self sealing couplings.	2.Fully connect all helium self sealing couplings.
Cryopump fails to cool down to the required operating temperature or takes too long to reach that temperature (20K).	3.Compressor problems.	3.Refer to the <i>On-Board IS 1000</i> <i>Compressor Installation,</i> <i>Operation and Maintenance</i> <i>Instructions</i> Helix part number 8040597.
	4.Leak in vacuum system or cryopump.	4.Check vacuum chamber and Hi-Vac valve for leaks. Check cryopump side of Hi-Vac valve for leaks.
	5.Helium gas line contamination.	5.See part number (document) 8040720 for more information about helium circuit decontamination.
Status LED III is not illuminated.	Network cable is disconnected from the On-Board <i>IS</i> Module.	Reconnect network cable to the On-Board <i>IS</i> Module.
Status LED III is Amber.	On-Board <i>IS</i> Cryopump Heater Failure	Refer to Appendix A - Customer Support Information for customer support information and contact Helix Technology Corporation for assistance.
Rough valve clicks but does not open and close.	Too little or no air pressure to drive valve.	Increase air pressure to 60 to 80 psig.
Purge valve clicks but does not open.	Too little or no air or nitrogen pressure to drive valve.	Increase air pressure to 60 to 80 psig. Increase nitrogen pressure to the correct pressure, 25 - 35 psig or 60 - 80 psig.

Table 3-1: On-Board IS Cryopump Troubleshooting Basic Causes and Actions

Problem	Possible Cause	Corrective Action
	1.Cryopump is not below 22K or is in regeneration.	1.Safety interlock.
	2.Gate Valve cabling is not connected	2.Connect cabling and clear gate valve error (gate valve will close and needs to be sensed closed).
Gate Valve does not operate.	3.Gate valve sensing is in error	3.Clear gate valve error. If the error does not clear, check voltages at the gate valve position indicators and at the cryopump. The gate valve error will need to be cleared anytime the gate valve cable is disconnected.

Table 3-1: On-Board IS Cryopump Troubleshooting Basic Causes and Actions

Technical Inquiries

NOTE: Refer to Appendix A - Customer Support Information for customer support information and assistance.

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Appendix A - Customer Support Information

Customer Support Center Locations

To locate a Customer Support Center near you, please visit our website *www.helixtechnology.com* on the world wide web and select *CONTACT* on the home page.

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Product Information

Please have the following information available when calling so that we may assist you:

- Product Part Number
- Product Serial Number
- Product Application
- Specific Problem Area
- Hours of Operation
- Equipment Type
- Vacuum System Brand/Model/Date of Manufacture

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For your convenience, you may also e-mail us at: techsupport@helixtechnology.com



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